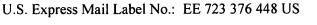
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## **ABSTRACT**

A semiconductor device in accordance with one example of the present invention pertains to a semiconductor device to be used for a CMOS inverter circuit, comprising a BOX layer 2 formed on a silicon substrate 1, a SOI film 3 comprising single crystal Si formed on the BOX layer, a gate oxide film 4 formed on the SOI film 3, a gate electrode 5 formed on the gate oxide film, and diffusion layers 7, 8 for source/drain regions formed in source/drain regions of the SOI film 3, wherein, when a power supply voltage of 0.6 V is used, a thickness  $T_{SOI}$  of the SOI film 3 is 0.084  $\mu$ m or greater and 0.094  $\mu$ m or smaller, and an impurity concentration of the SOI film is  $7.95 \times 10^{17}/\text{cm}^3$  or greater and  $8.05 \times 10^{17}/\text{cm}^3$  or smaller.

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